

PIC Training System Manual **Rev. 1-1**

Department of Engineering Technology
Electrical Engineering Technology
Old Dominion University
Norfolk, VA 23529

August 31, 2012

Introduction

This is a revision (Rev1-1) of the PIC Training system that was a NSF CCLI funded project to address the hands-on distance learning needs in microprocessor/ microcontroller related courses with a research team designing a low cost training system with supporting instructional materials to assist the teaching of these concepts. Individual laboratory activities are being developed to reinforce student learning and skill development in programming concepts. This basic system format eventually will support an array of technology courses. This project involves two community colleges, Blue Ridge Community College (BRCC), VA, Tidewater Community College (TCC), VA, and a four-year university, Old Dominion University (ODU), VA, Wayne State University (WSU), and California State University-Fresno (CSUF) in a collaborative research team to design and develop a specific PIC microcontroller training system with customized designed software and curriculum materials to support related engineering technology courses. The functions of the hardware and software cover different areas of engineering technology courses and majors to maximize the use of the system.

Special thanks to Mr. Marc McComb, Academic Program Engineer at Microchip Inc., who has supported all the Microchip products used in this system.



Training System Operations Overview

These training system operations are classified in hardware and software categories.

Hardware: There many elements such as LED drivers, DIP switch inputs, 7-segment connections & drivers, Max232 configurations, DAC connection, EEPROM connections, 2.4 GHZ MRF24J40MA RF module, SPI interface, LCD connections, 3*4 keypad pins pull up, DB25 Parallel port I/O buffered interface connections, optical isolator connections, power FET configurations, and 8 bit SPDT hardware switch debounce are already done on the PCB (Printed Circuit Board). Users are only

required to use proper interface between the PIC microcontroller pins and available modules on board to do the desired experimentations. The hardware operations and pin description is detailed in the “Hardware Operation” section.

The physical orientation of all the connectors on the PCB are exactly the same as presented in the following graphic symbols.

Software: There are two kinds of software that can run on this training system. The “PICKIT2” that is downloadable from www.microchip.com/pickit2 runs on a PC USB port and its operations are detailed in the first part of “Software Operation” section. The other software is “ICPROG” that is downloadable from www.ic-prog.com/index1.htm runs on a PC DB25 parallel port. The operation is also introduced in the second part of “Software Operation” section.

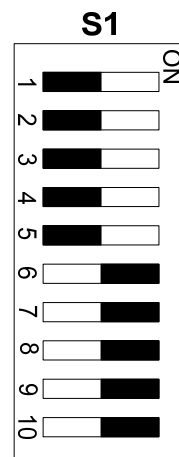
PCI MCU Programming mode vs. Operation mode:

This PIC Training System is capable to program and re-program the PIC MCU that stays in the 40 Pin ZIF socket and running user's operation software without relocating the MCU. Here are the ways of exchange between these programming and operation modes:

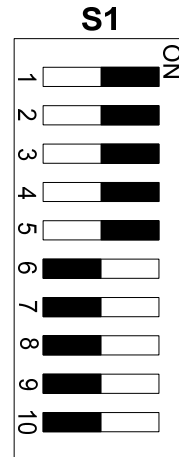
Programming:

1. Place the MCU (notch mark placed against to the top, see Page #5) properly in the 40Pin ZIF socket and lock it with the arm down.
2. Set the package selection switches (S1) as following, also see S1 switch on Page # 8.

(1) DIP switch 1-5 off and
6-10 on → Used with 18
Pin PIC

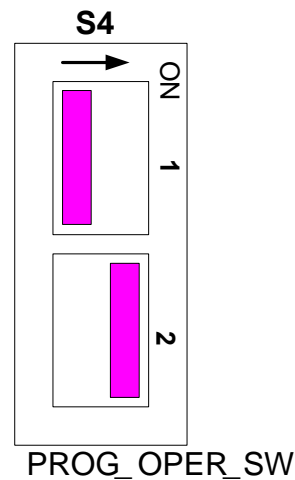


- (2) DIP switch 1-5 on and 6-10 off → Used with 28 or 40 Pin PIC

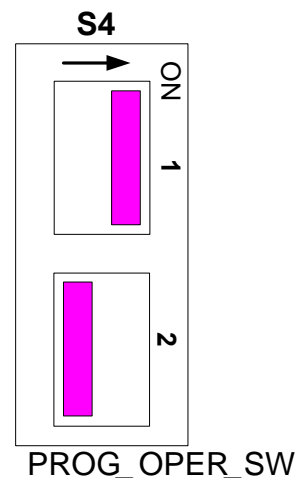


3. Set the S4 switch properly for target MCU in programming/re-programming operation mode, also see S4 switch on Page # 9.

- (1) SW1 off & SW2 on → Use with 18 Pin PIC Programming



- (2) SW1 on & SW2 off → Use with 28 or 40 Pin PIC Programming



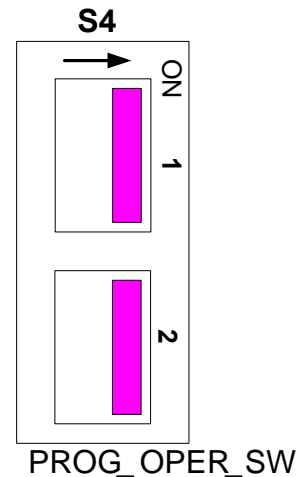
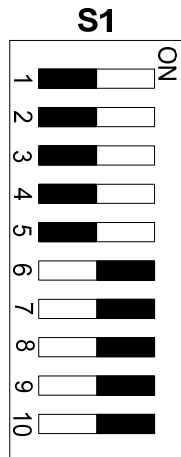
4. Connect USB cable to USB connector X1.
5. Connect the power to J1 power jack.
6. Run PICKT2 or MPLAB software

7. The software should recognize the target MCU in the 40Pin ZIF socket.
8. From here you can **Import** the .HEX file then click **Write** to program the MCU.

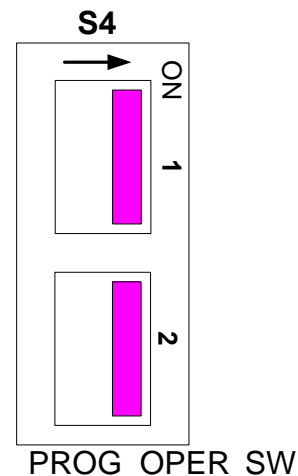
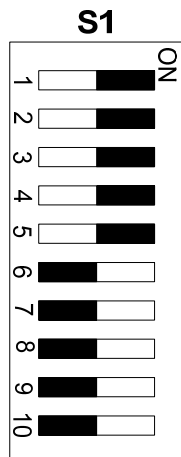
Normal Operation:

1. Set **S1** and **S4** on/off for normal/evaluation operation as following:

S4: SW1 on & SW2 on → Use with all 18 Pin PIC Normal Operations



S4: SW1 on & SW2 on → Use with all 28 & 40 Pin PIC Normal Operations



2. Simple press the S2 (for 18 pin PIC) or S3 (for 28 or 40 pin PIC) reset switch, the MCU should boot and run the loaded source code (your .HEX file).

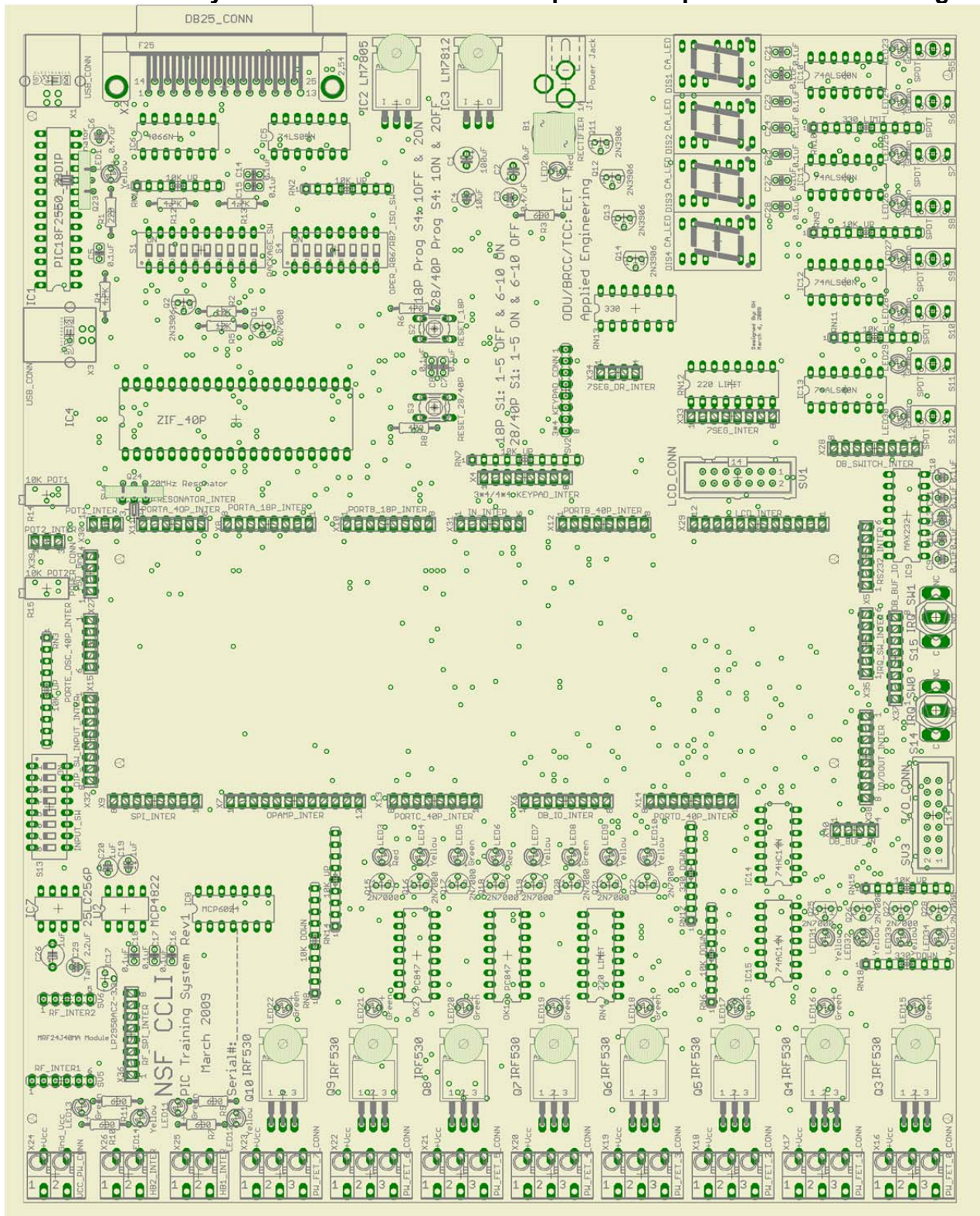
Re-programming:

1. Leave S1 package selection switches unchanged and set S4 for different PIC programming settings as:
 - (1) **SW1 off & SW2 on → Use with 18 Pin PIC Programming**
 - (2) **SW1 on & SW2 off → Use with 28 or 40 Pin PIC Programming**
2. Under PICKIT2 “Tools” manual, select “**Check Communication**”. This should stop the operation mode of the MCU and force it in programming mode. The software should recognize the target MCU in the ZIF socket.
3. If is not successful, press and hold the RESET switch (S2 for 18 Pin PIC or S3 for 28 or 40 Pin PIC) do it again, then the PICKIT2 should recognize the target MCU.

4. If the target MCU still can NOT be recognized, check/do the following:
 - (1) Make sure your application interfaces are not pulled the RB6 and RB7 I/O pins down.
 - (2) If they are, then your choices are
 - (a) **Press and hold the RESET** switch (**S2** for 18 Pin PIC or **S3** for 28 or 40 Pin PIC), then click the “**Check Communication**” make sure the target MCU is recognized by the software, the re-program the MCU in following step #5, after it is done, then power down reconnect the RB6 and RB7 interfaces, then power up. The system should run with your new .HEX file, ignore a signal if it says “Verification Failed”.
 - (b) Power down the system, disconnect the RB6 and RB7 interfaces, power up then click the “**Check Communication**” make sure the target MCU is recognized by the software, the re-program the MCU in following step #5, after it is done, then power down reconnect the RB6 and RB interfaces, then power up. The system should run with your new .HEX file, ignore a signal if it says “Verification Failed”.
 - (c) Power down the system, disconnect the OSC1 and OSC2 resonator interface between SV4 and MCU oscillator pins, power up the system, then click the “**Check Communication**” make sure the target MCU is recognized by the software, the re-program the MCU in following step #5, after it is done, then power down reconnect the OSC1 and OSC2 interfaces, then power up. The system should run with your new .HEX file, ignore a signal if it says “Verification Failed”.
5. **Press and hold the RESET switch** (**S2** for 18 Pin PIC or **S3** for 28 or 40 Pin PIC), under the main manual “**File**”, select “**Import Hex**”, choose the proper .HEX file then click on “**Write**” to re-program the target MCU. At this point you may encounter a verification fail, but the .HEX should be already programmed and the MCU should start running with your new code. Ignore a signal if it says “Verification Failed”.

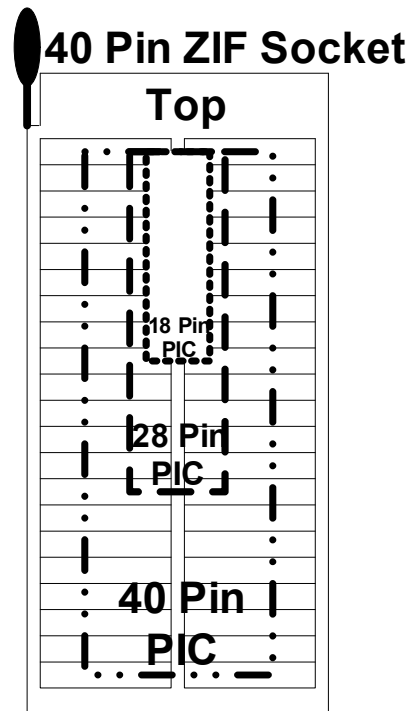
Hardware Operation

The PCB layout of all the electronic components is presented as following:



Low Power Section

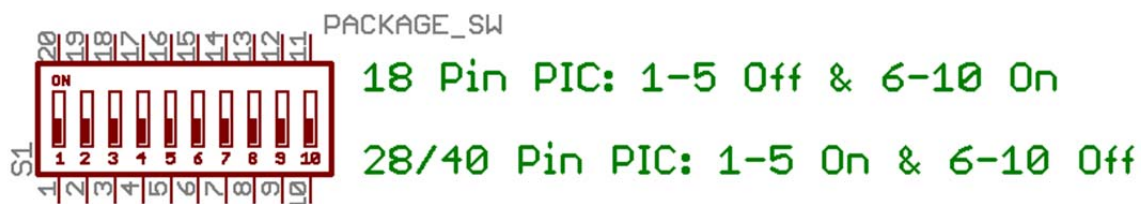
1. **40Pin ZIF Socket (IC4):** It is a universal zero insertion force (ZIF) socket that is to host different DIP pin package PIC microcontroller for programming. The position of different pin package is to place the PIC direct against top (the movable arm side), the notch mark should be facing toward the top. The following is a graphic illustration:



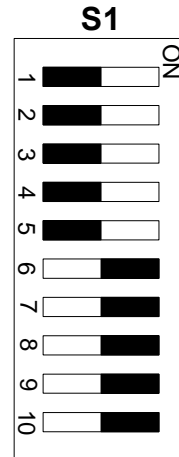
2. **Power Jack Connector (J1):** It takes either DC or AC power (9V-14V) from a wall mount plug in power supply. The board has a bridge rectifier to take any power and regulates a +5V for normal MPU operation and a +12V for flash and EEPROM memories programming needs. A wall mount power supply is included in the package.

Note: The polarity on the power jack plug make no difference to the trainer board.

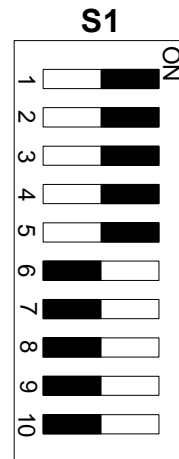
3. **Package Selection DIP Switch (PACKAGE SW, S1):** This 10 positions DIP switch is used to selection different DIP pin package PIC for programming. The following are the choices:
The S1 controls are:



- (1) DIP switch 1-5 off and 6-10 on → Used with 18 Pin PIC Programming



- (2) DIP switch 1-5 on and 6-10 off → Used with 28 or 40 Pin PIC Programming



Note: Be sure the power plug is disconnected before changing any setting on this DIP switch.

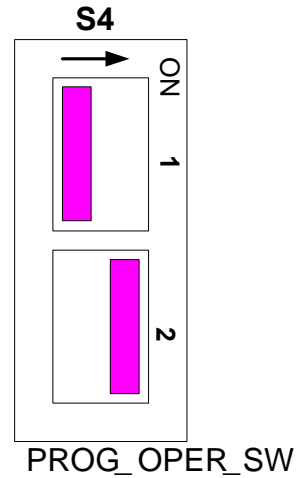
The S1 controls are:



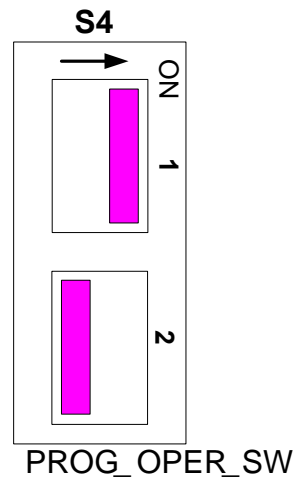
4. **Programming and Operation Selection DIP Switch (PROG OPER SW, S4):**
This 2 positions DIP switch is used for programming operation of the target PIC that is inserted in the ZIF socket. The following are the choices:

The S4 controls are:

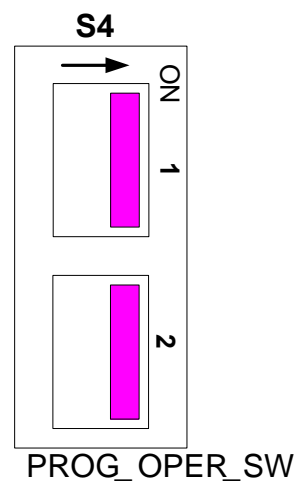
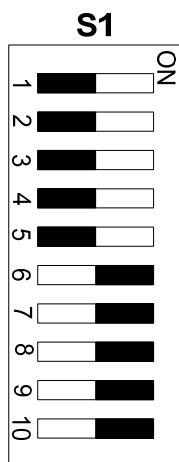
- (1) SW1 off & SW2 on →
Use with 18 Pin PIC
Programming



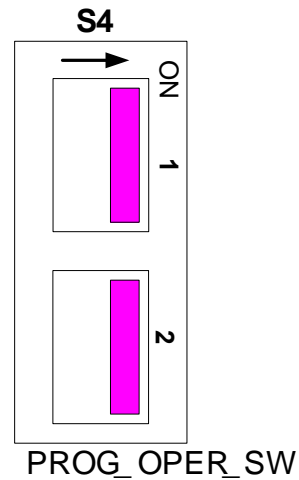
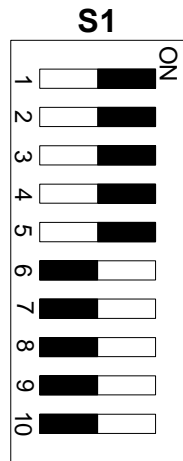
- (2) SW1 on & SW2 off →
Use with 28 or 40 Pin PIC
Programming



Normal Operation:
Set S1 and S4 on/off as following:
Use with 18 Pin PIC



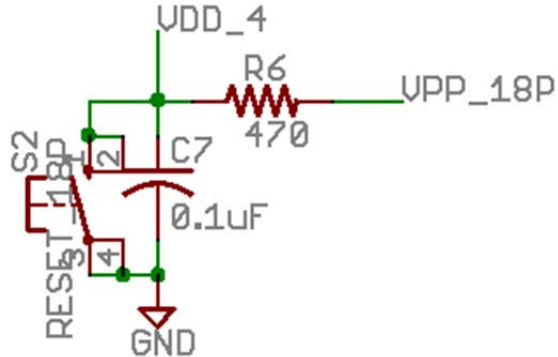
Use with 28 or 40 Pin PIC



Note: The power should be disconnected before changing any of the switches.

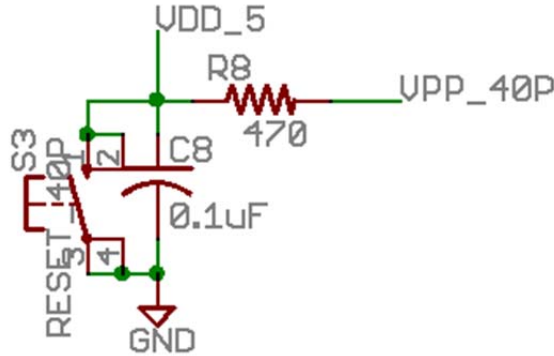
5. RESET Switch or 18 Pin PIC (S2):

This the MCLR pin connection to the 18 pin PIC for any system RESET needs.
The circuit is configured as:



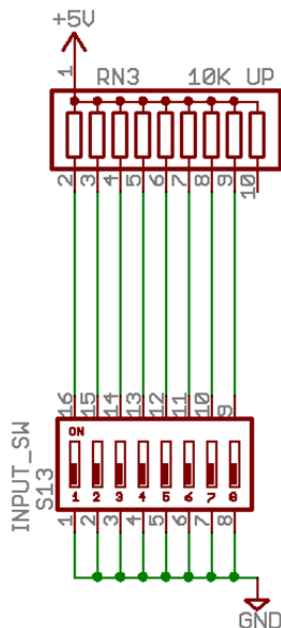
6. RESET Switch or 28 or 40 Pin PIC (S3):

This the MCLR pin connection to the 18 pin PIC for any system RESET needs.
The circuit is configured as:



7. **8 Positions DIP Digital Input Switch (S13)**: This provides 8 bits input to any experimental circuit.

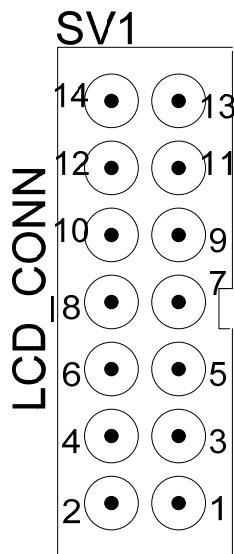
The S13 pin connections are:



DIP Switch #1	➔	10K Pull up to +5V
DIP Switch #2	➔	10K Pull up to +5V
DIP Switch #3	➔	10K Pull up to +5V
DIP Switch #4	➔	10K Pull up to +5V
DIP Switch #5	➔	10K Pull up to +5V
DIP Switch #6	➔	10K Pull up to +5V
DIP Switch #7	➔	10K Pull up to +5V
DIP Switch #8	➔	10K Pull up to +5V

8. **IRQ Switch 0 (S14)**: This SPDT switch (with C, NC, & NO) provides the interrupt signal to any experimental circuit. There is no hardware debounce and resistor pull up or pull down, it is user's responsibility to add external component to use this switch.
9. **IRQ Switch 1 (S15)**: This SPDT switch (with C, NC, & NO) provides the interrupt signal to any experimental circuit. There is no hardware debounce and resistor pull up or pull down, it is user's responsibility to add external component to use this switch.
10. **LCD Module Connector (SV1)**: It is used for 14 pin LCD module connection, all the 14 pin connections are available through LCD interface (X29, See Page #21) that is place by the side of the 2.2"×6.5" breadboard. The LCD module is included in the package.

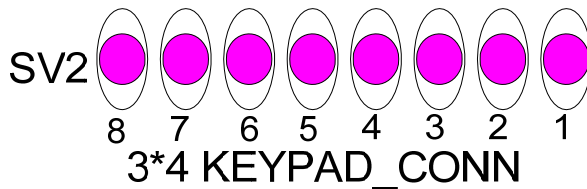
The SV1 pins connections are:



Pin #1	→	VDD ==	+5V
Pin #2	→	VSS ==	Gnd
Pin #3	→	LCD_RS	
Pin #4	→	LCD_VO	
Pin #5	→	LCD_E	
Pin #6	→	LCD_R/W	
Pin #7	→	LCD_D1	
Pin #8	→	LCD_D0	
Pin #9	→	LCD_D3	
Pin #10	→	LCD_D2	
Pin #11	→	LCD_D5	
Pin #12	→	LCD_D4	
Pin #13	→	LCD_D7	
Pin #14	→	LCD_D6	

11. **3*4 Keypad Connector (SV2)**: It is used for a 3*4 or 4*4 matrix keypad connection, all 12 pins are pull high through 10K resistors. The keypad should be directly inserted into this connection socket. This keypad interface is available on X4 (See Page #12) in-line female socket connector. The 3*4 keypad is included in the package.

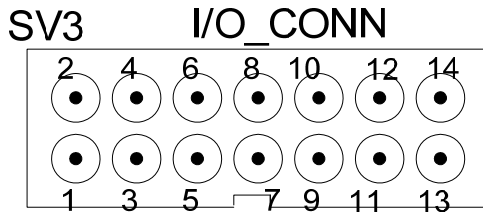
The SV2 pins connections are:



Pin #1	→	10K Pull up to +5V
Pin #2	→	10K Pull up to +5V
Pin #3	→	10K Pull up to +5V
Pin #4	→	10K Pull up to +5V
Pin #5	→	10K Pull up to +5V
Pin #6	→	10K Pull up to +5V
Pin #7	→	10K Pull up to +5V
Pin #8	→	10K Pull up to +5V

12. **I/O Connector (SV3)**: An I/O expansion port that takes all the I/O pins off the DB25 for future modular board expansion. Its associated interface is available on X38 (IO_0 to IO_7) & X31 (IN_3 to IN_7) in-line female socket connectors.

The SV3 pins connections are:

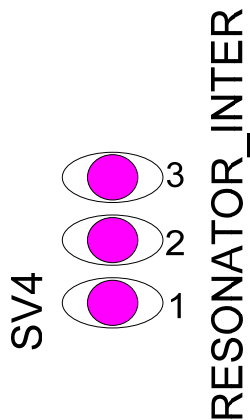


Pin #1 → IO_0
 Pin #2 → IO_1
 Pin #3 → IO_2
 Pin #4 → IO_3
 Pin #5 → IO_4
 Pin #6 → IO_5
 Pin #7 → IO_6

Pin #8 → IO_7
 Pin #9 → IN_3
 Pin #10 → IN_5
 Pin #11 → IN_6
 Pin #12 → IN_7
 Pin #13 → Gnd
 Pin #14 → +5V

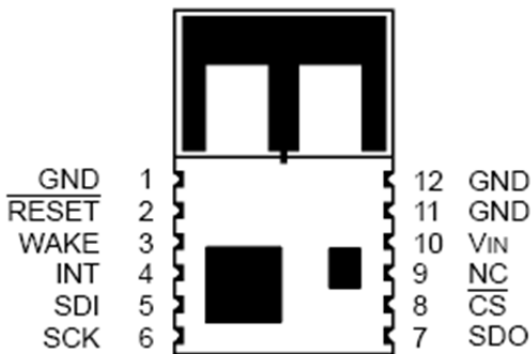
13. Resonator Interface Connector (SV4): This is an interface for those MCUs (PIC16F84A, PIC16F877A) that need external clock signal to be built with experimental circuit on the 2.2”*6.5” breadboard. The center Gnd pin already wired to the system Gnd trace.

The SV4 pins connections are:

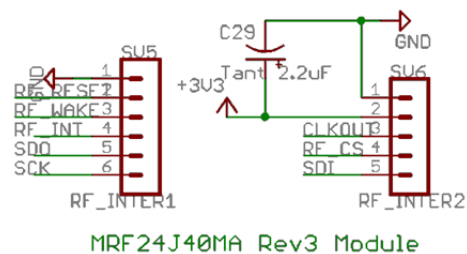


Pin #1 → OSC1 ==
 Resonator Pin 1
 Pin #2 → Gnd ==
 Resonator Center Pin
 Pin #3 → OSC2 ==
 Resonator Pin 2

14. MRF24J40MA 2.4 GHz Module Sockets (SV5 & SV6): This a combination of SV5 & SV6 sockets for MRF24J40MA module connection. There is only one orientation of the module that is its antenna has to point out of the PIC Trainer board. The available interface connector is on X36 (See Page #24)
 This is an actual picture of this MRF24JMA, 2.4 GHz module and its associated interface pins:



The associated circuit is:



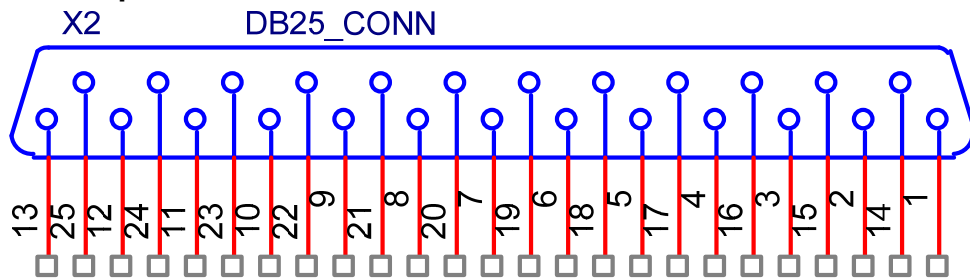
15. **PIC18F2550 on a 18 Pin Narrow Socket (IC1)**: This is a resident PIC that is used for communication to a PC via an USB port. It is supposed to be on the socket all the time. Do NOT remove this PIC for any other purpose.
16. **Red LED (LED2)**: It is an indication of the present of the power source. Any time the wall mount power plug into the power jack, this RED LED will light.
17. **Yellow LED (LED1)**: It is an indication of the USB communication. When it flashes that indicates the communications processes are either in identifying the type of the PIC, programming a HEX file to the PIC, reading the flash/EEPROM off the PIC, verifying the content of the flash/EEPROM of the PIC, or erasing the content of the PIC.
18. **LM7805 Regulator (IC2)**: This is a +5V power regulator and it can provide +5V power up to 1A. If the max 1A power is need constantly, a heat sink should be mounted to this TO222 package.
19. **LM7812 Regulator (IC3)**: This is a +12V power regulator and it can provide +12V power up to 1A. If the max 1A power is need constantly, a heat sink should be mounted to this TO222 package.

Note: Any operation should not cause these LM7805& LM7812 to be hot. If the temperature is hot at these devices, the power jack should be

disconnecting immediately and check for any short circuit. During the normal operation this LM7805 & LM7812 should only be warm and touchable by a finger.

20. **USB Connector (X1):** It is an USB type B female receptacle connector that is used for regular USB communication to a PC. An USB cable with Type A-B connector is included in the package.
21. **DB 25 Connector (X2):** This is used for a PC parallel port communication to the training system. It will isolate the USB port if it is plugged into a PC to prevent any clash between USB and DB25 communications at the same time. This connector is also served as controls from a PC to any peripheral devices on this training system. It is intended for high level language programming exercises if they are needed. It can also extend to an additional modular board through I/O Connector (SV3) for any future expansion. Its associated interface connectors are available on X6, X37, & X40 (See Page #13, #25, & #26) A DB25 male-female end cable with is included in the package.

The X2 pins connections are:



- Pin #1 ➔ CLK: PC DB25 Parallel Port Programming Clock Signal
- Pin #2 ➔ DB_IO_0: PC DB25 Data Bit 0
- Pin #3 ➔ DB_IO_1: PC DB25 Data Bit 1
- Pin #4 ➔ DB_IO_2: PC DB25 Data Bit 2
- Pin #5 ➔ DB_IO_3: PC DB25 Data Bit 3
- Pin #6 ➔ DB_IO_4: PC DB25 Data Bit 4
- Pin #7 ➔ DB_IO_5: PC DB25 Data Bit 5
- Pin #8 ➔ DB_IO_6: PC DB25 Data Bit 6
- Pin #9 ➔ DB_IO_7: PC DB25 Data Bit 7
- Pin #10 ➔ DB_IN6: PC DB25 Input Data Bit 6
- Pin #11 ➔ DB_IN7: PC DB25 Input Data Bit 7
- Pin #12 ➔ DB_IN5: PC DB25 Input Data Bit 5
- Pin #13 ➔ Data Feedback: DB25 Parallel Port Programming Data Feedback Signal
- Pin #14 ➔ USB_ISO: Isolate USB Port for PC DB25 Parallel Port Programming
- Pin #15 ➔ DB_IN3: PC DB25 Input Data Bit 3
- Pin #16 ➔ VPP_CON: VPP Pulse Control for PC DB25 Parallel Port Programming

Pin #17 → DAT: PC DB25 Parallel Port Programming Data Signal

Pin #18 – Pin#25: Gnd

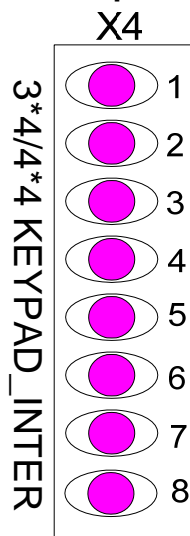
Its associated IN interfaces are available on X6 (DB_IO_0 to DB_IO_7) & X40 (DB_IN3 to DB_IN7) and Buffered OUT interfaces are on X37 (BUF_IO_0 to BUF_IO_7) in-line female socket connectors.

22. **USB Connector (X3)**: It is another USB type B female receptacle connector that is used for experimental USB communication to a PC or any other device. The interface connection of +D, -D, Gnd are already set up to the USB port pins on a PIC18F2550 that should be inserted in the ZIF socket.

Note: This is not a replacement of the programming USB communication port as X1 that is used for the dedicated PIC18F2550 on the training system. Its intent is for needed lab experimentation uses.

23. **3*4 Keypad Interface Connector (X4)**: This is an in-line female socket interface connector for the 3*4 keypad to be used with experimental circuit on the 2.2"*6.5" breadboard.

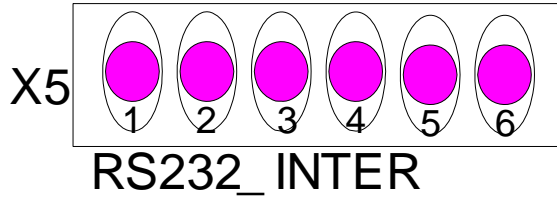
The X4 pins connections are:



- | | | |
|--------|---|--------------------|
| Pin #1 | → | 10K Pull up to +5V |
| Pin #2 | → | 10K Pull up to +5V |
| Pin #3 | → | 10K Pull up to +5V |
| Pin #4 | → | 10K Pull up to +5V |
| Pin #5 | → | 10K Pull up to +5V |
| Pin #6 | → | 10K Pull up to +5V |
| Pin #7 | → | 10K Pull up to +5V |
| Pin #8 | → | 10K Pull up to +5V |

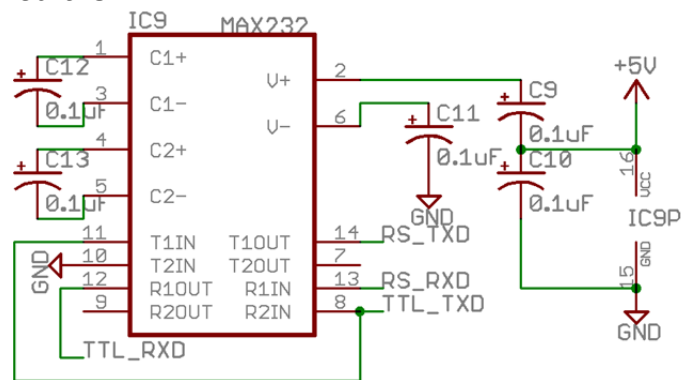
24. **MAX232 Interface Connector (X5)**: This is an interface for the MAX232 be used as RS232-TTL communication experimental circuit on the 2.2"*6.5" breadboard. The MAX232 has all the needed capacitors and power to function properly.

The X5 pins connections are:



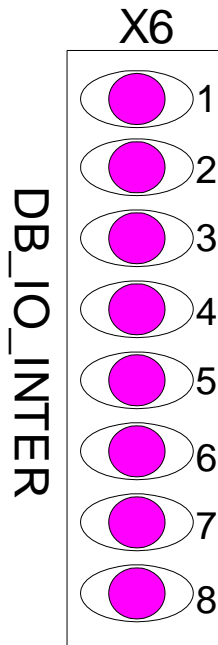
Pin #1 → +5V
 Pin #2 → RS_TxD → RS232 Transmission Data Line
 Pin #3 → RS_RxD → RS232 Receive Data Line
 Pin #4 → TTL_TxD → TTL Transmission Data Line
 Pin #5 → TTL_RxD → TTL Receive Data Line
 Pin #6 → Gnd

The associated circuit is:



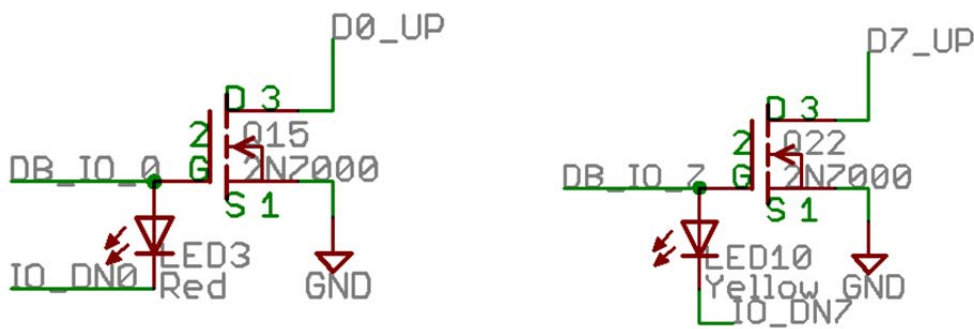
25. DB IO Interface Connector (X6): These are signals to control 8 on board LEDs (LED3-LED10) to be used on experimental circuit on the 2.2”*6.5” breadboard.

The X6 pins connections are:



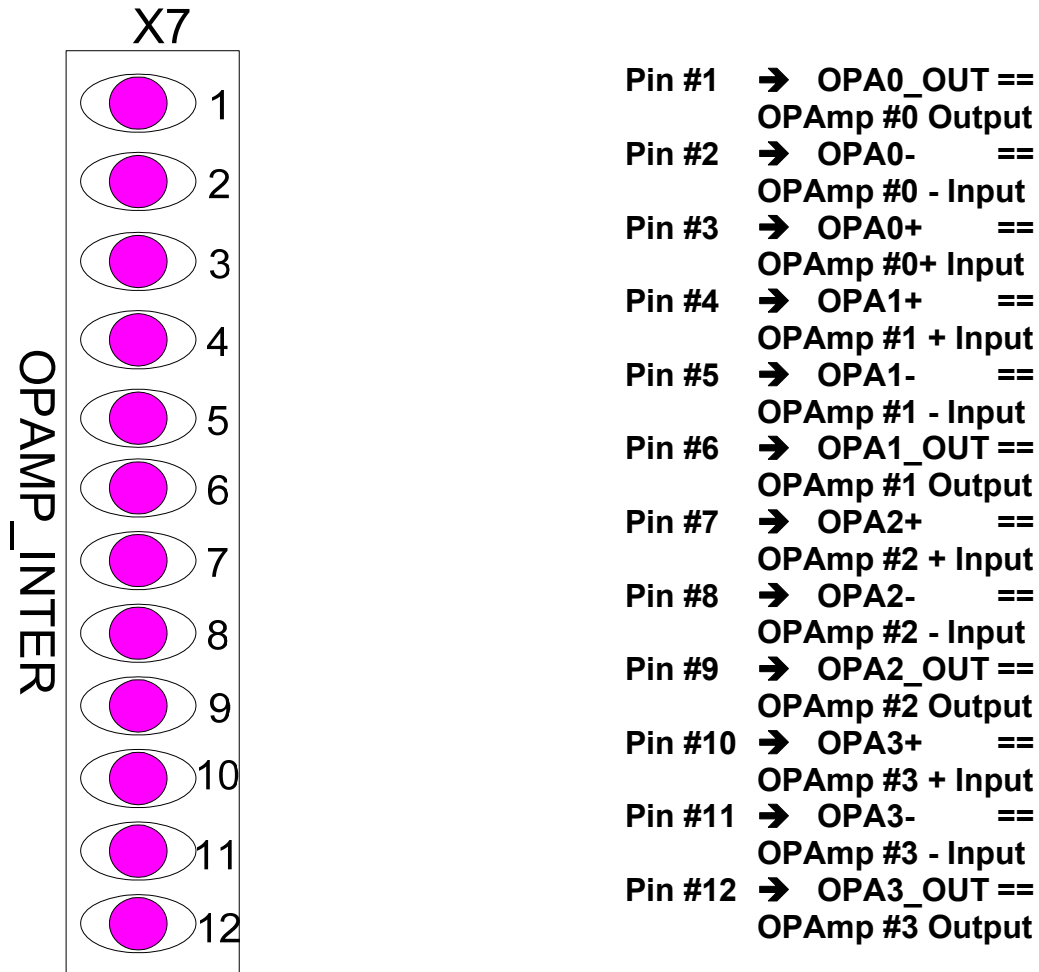
- Pin #1 → DB_IO_0 == Data Bit 0
Control Red LED 3
- Pin #2 → DB_IO_1 == Data Bit 1
Control Yellow LED 4
- Pin #3 → DB_IO_2 == Data Bit 2
Control Green LED 5
- Pin #4 → DB_IO_3 == Data Bit 3
Control Red LED 6
- Pin #5 → DB_IO_4 == Data Bit 4
Control Yellow LED 7
- Pin #6 → DB_IO_5 == Data Bit 5
Control Green LED 8
- Pin #7 → DB_IO_6 == Data Bit 6
Control Yellow LED 9
- Pin #8 → DB_IO_7 == Data Bit 7
Control Yellow LED 10

It associated circuit is:



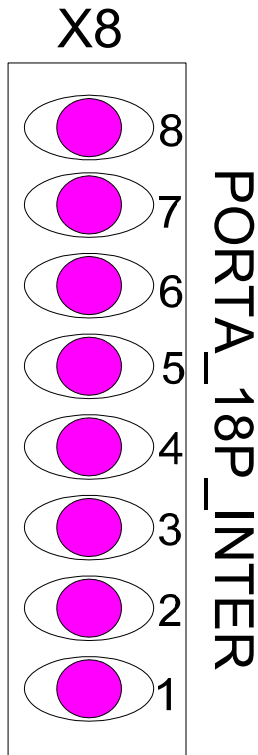
26. OPAMP Interface Connector (X7): This is an interface for MCP6024 that is a general Operational Amplifier to be built with experimental circuit on the 2.2"×6.5" breadboard. This MCP6014 has four OPAMPs in one package for any conditional circuit to be used.

The X7 pins connections are:



27. Port A 18 Pin Interface Connector (X8): This provides PIC16F84A and PIC16F88 PORTA signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

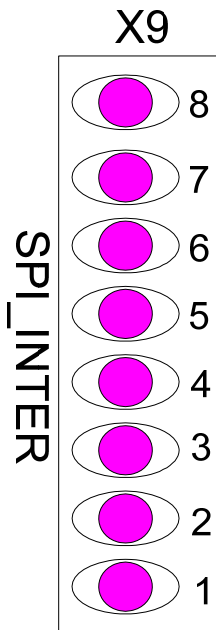
The X8 pins connections are:



Pin #1	→ CLK_40P_ZIF ==
	18P: RA0, 40P: RB6/PGC
Pin #2	→ DAT_40P_ZIF ==
	18P: RA1, 40P: RB7/PGD
Pin #3	== VPP_40P ==
	18P: RA2,
	40P: MCLR/VPP
Pin #4	→ RA3_18P ==
	18P: RA3, 40P: RA0/AN0
Pin #5	→ RA4_18P ==
	18P: RA4/TOCKI,
	40P: RA1/AN1
Pin #6	→ VPP_18P ==
	18P: MCLR,
	40P: RA2/AN2/VREF-/CVREF
Pin #7	→ RA6_OSC2_18P ==
	18P: RA6/OSC2/CLKOUT,
	40P: RB4
Pin #8	→ RA7_OSC1_18P ==
	18P: RA7/OSC1/CLKIN,
	40P: RB5

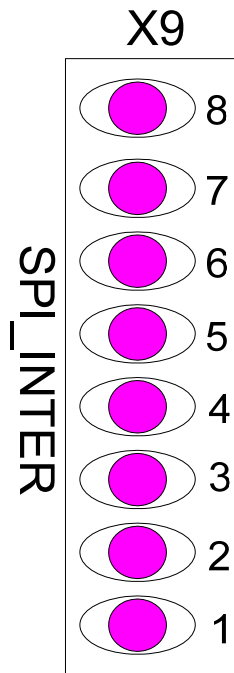
28. SPI Interface Connector (X9): This is an interface for 25LC256P (32KB EEPROM) or MCP4822 (DAC) that is SPI signal control to be built with experimental circuit on the 2.2”*6.5” breadboard.

The X9 pins connections are: (If the MCP 4822 that has two DAC channels is used on the training system.)



Pin #1	→ EE_CS ==
	EEPROM Chip Select
Pin #2	→ SCK ==
	SPI Clock Signal
Pin #3	→ SDO ==
	SPI Data Out
Pin #4	→ SDI ==
	SPI Data In
Pin #5	→ LDAC ==
	DAC LDAC Signal
Pin #6	→ OUTA ==
	DAC Channel A Out
Pin #7	→ OUTB ==
	DAC Channel B Out
Pin #8	→ DAC_CS ==
	DAC Chip Select

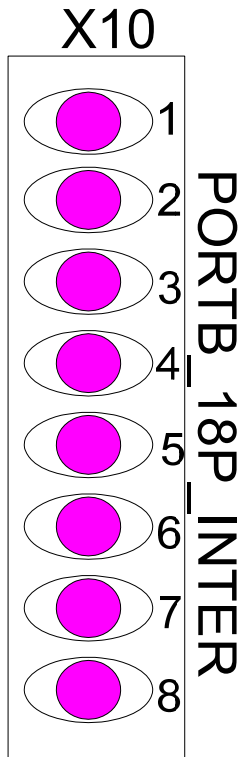
The X9 pins connections are: (If the MCP 4821 that has one DAC channel is used on the training system.)



Pin #1	→	EE_CS	==	EEPROM Chip Select
Pin #2	→	SCK	==	SPI Clock Signal
Pin #3	→	SDO	==	SPI Data Out
Pin #4	→	SDI	==	SPI Data In
Pin #5	→	LDAC	==	DAC LDAC Signal
Pin #6	→	OUTA	==	DAC Channel A Out
Pin #7	→	SHDN	==	DAC Channel A Shut Down Control
Pin #8	→	DAC_CS	==	DAC Chip Select

29. Port B 18 Pin Interface Connector (X10): This provides PIC16F84A and PIC16F88 PORTB signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

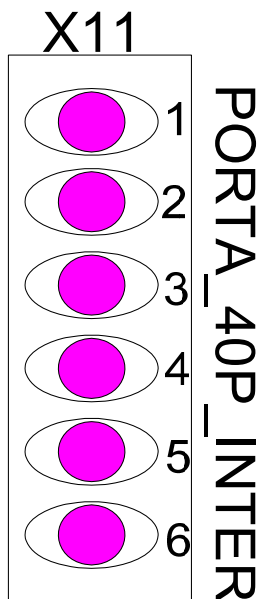
The X10 pins connections are:



Pin #1	➔	RB0_18P	==
		18P: RB0/INT0,	
		40P: RB4/TOCK1C1OUT	
Pin #2	➔	RB1_18P	==
		18P: RB1,	
		40P: RA5/AN4/SS/C2OUT	
Pin #3	➔	RB2_18P	==
		18P: RB2,	
		40P: RE0/RD/AN5	
Pin #4	➔	RB3_18P	==
		18P: RB3,	
		40P: RE1/WR/AN6	
Pin #5	➔	VDD_40P	==
		18P: RB4, 40P: VDD	
Pin #6	➔	RB5_18P	==
		18P: RB5, 40P: RB0/INT	
Pin #7	➔	CLK_18P_ZIF	==
		18P: RB6, 40P: RB1	
Pin #8	➔	DAT_18P_ZIF	==
		18P: RB7, 40P: RB2	

30. Port A 40 Pin Interface Connector (X11): This provides PIC16F877A PORTA signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

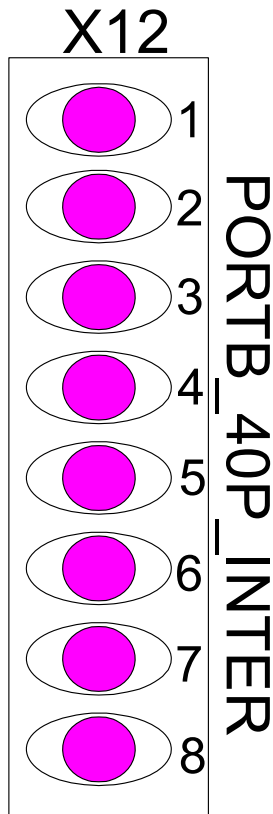
The X11 pins connections are:



Pin #1	➔	RA3_18P	==
		40P: RA0/AN0, 18P: RA3	
Pin #2	➔	RA4_18P	==
		40P: RA1/AN1, 18P: RA4	
Pin #3	➔	VPP_18P	==
		40P: RA2/AN2/VREF-/CVREF ,	
		18P: MCLR	
Pin #4	➔	GND_18P	==
		40P: RA3/AN3/VREF+,	
		18P: VSS	
Pin #5	➔	RB0_18P	==
		40P: RA4/TOCKI/C1OUT ,	
		18P: RB0/INT	
Pin #6	➔	RB1_18P	==
		40P: RA5/AN4/SS/C2OUT,	
		18P: RB1	

31. Port B 40 Pin Interface Connector (X12): This provides PIC16F877A PORTB signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

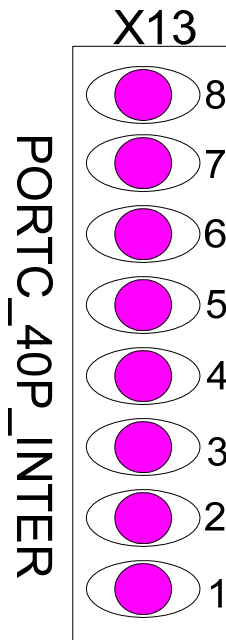
The X12 pins connections are:



Pin #1	➔	RB5_18P	==
		40P: RB7/PGD, 18P: RA1	
Pin #2	➔	CLK_18P_ZIF	==
		40P: RB6/PGC, 18P: RA0	
Pin #3	➔	DAT_18P_ZIF	==
		40P: RB5,	
		18P: RA7/OSC1/CLKIN	
Pin #4	➔	VDD_18P	==
		40P: RB4,	
		18P: RA6/OSC2/CLKOUT	
Pin #5	➔	RA6_OSC2_18P	==
		40P: RB3/PGM, 18P: VDD	
Pin #6	➔	RA7_OSC1_18P	==
		40P: RB2, 18P: RB7	
Pin #7	➔	CLK_40P_ZIF	==
		40P: RB1, 18P: RB6	
Pin #8	➔	DAT_40P_ZIF	==
		40P: RB0/INT, 18P: RB5	

32. Port C 40 Pin Interface Connector (X13): This provides PIC16F877A PORTC signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

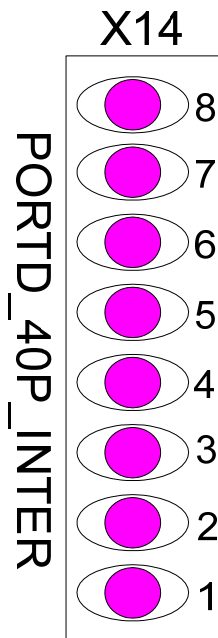
The X13 pins connections are:



Pin #1	→	RC0_40P ==
		40P: RC0/T1OSO/T1CKI
Pin #2	→	RC1_40P ==
		40P: RC1/T1OSI/CCP2
Pin #3	→	RC2_40P ==
		40P: RC2/CCP1
Pin #4	→	RC3_40P ==
		40P: RC3/SCK/SCL
Pin #5	→	RC4_40P ==
		40P: RC4/SDI/SDA
Pin #6	→	RC5_40P ==
		40P: RC5/SDO
Pin #7	→	RC6_40P ==
		40P: RC6/TX/CK
Pin #8	→	RC7_40P ==
		40P: RC7/RX/DT

33. Port D 40 Pin Interface Connector (X14): This provides PIC16F877A PORTD signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

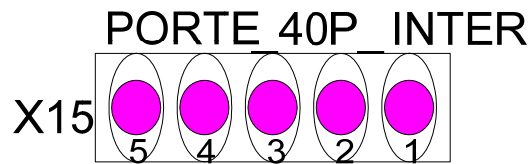
The X14 pins connections are:



Pin #1	→	RD0_40P ==
		40P: RD0/PSP0
Pin #2	→	RD1_40P ==
		40P: RD1/PSP1
Pin #3	→	RD2_40P ==
		40P: RD2PSP2
Pin #4	→	RD3_40P ==
		40P: RD3/PSP3
Pin #5	→	USB_D- ==
		40P: RD4/PSP4, 28P: USB D-
Pin #6	→	USB_D+ ==
		40P: RD5/PSP5, 28P: USB D+
Pin #7	→	RD6_40P ==
		40P: RD6/PSP6
Pin #8	→	RD7_40P ==
		40P: RD7/PSP7

34. Port E 40 Pin Interface Connector (X15): This provides PIC16F877A PORTE signal interface to be used on experimental circuit on the 2.2”*6.5” breadboard.

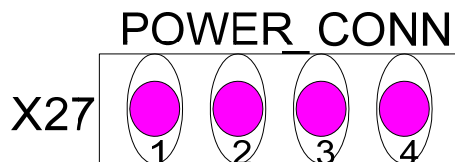
The X15 pins connections are:



Pin #1 → RB2_18P == 40P: RE0/RD/AN5
 Pin #2 → RB3_18P == 40P: RE1/WR/AN6
 Pin #3 → RE2_40P == 40P: RE2/CS/AN7
 Pin #4 → OSC1_40P == 40P: OS1I/CLKI
 Pin #5 → OSC2_40P == 40P: OSC2/CLKO

35. **DC Power Source (X27)**: This +5V power source that is on two terminal block posts (one for +5V the other for Gnd) for providing power source to any experimental circuit on the 2.2”*6.5” breadboard.

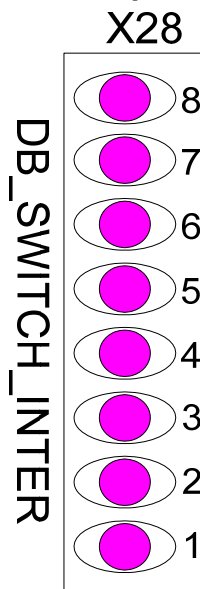
The X27 pins connections are:



Pin 1 & Pin 2 → +5V
 Pin 3 & Pin 4 → Gnd

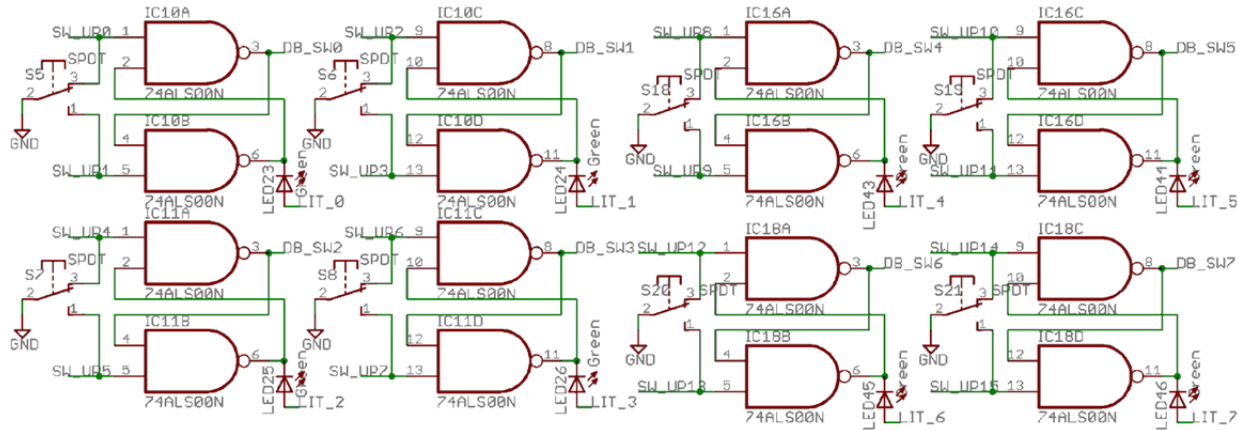
36. **Debounced Switches Connector (X28)**: This is an interface debounced SPDT switches of S5-S12 to be used with experimental circuit on the 2.2”*6.5” breadboard.

The X28 pins connections are:



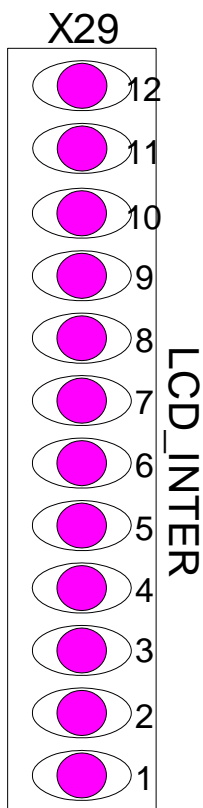
Pin #1 → DB_SW0 == Controlled by S5
 Pin #2 → DB_SW1 == Controlled by S6
 Pin #3 → DB_SW2 == Controlled by S7
 Pin #4 → DB_SW3 == Controlled by S8
 Pin #5 → DB_SW4 == Controlled by S9
 Pin #6 → DB_SW5 == Controlled by S10
 Pin #7 → DB_SW6 == Controlled by S11
 Pin #8 → DB_SW7 == Controlled by S12

The associated circuit of these 8 hardware debounced switches are:



37. LCD Interface Connector (X29): This is an interface for the LCD to be used with experimental circuit on the 2.2”*6.5” breadboard.

The X29 pins connections are:

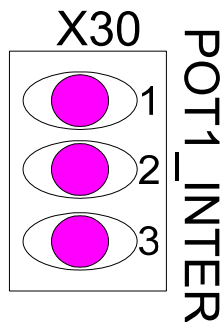


Pin #1	→	LCD_D0	(LCD Pin #7)
Pin #2	→	LCD_D1	(LCD Pin #8)
Pin #3	→	LCD_D2	(LCD Pin #9)
Pin #4	→	LCD_D3	(LCD Pin #10)
Pin #5	→	LCD_D4	(LCD Pin #11)
Pin #6	→	LCD_D5	(LCD Pin #12)
Pin #7	→	LCD_D6	(LCD Pin #13)
Pin #8	→	LCD_D7	(LCD Pin #14)
Pin #9	→	LCD_RS	(LCD Pin #4)
Pin #10	→	LCD_E	(LCD Pin #6)
Pin #11	→	LCD_R/W	(LCD Pin #5)
Pin #12	→	LCD_VO	(LCD Pin #3)

Note: LCD Pin #1, Vss, is Grounded
and LCD Pin #2, Vdd is Powered
by +5V on the board.

38. Potentiometer 1 Interface Connector (X30): These are signals from 10K Ω Trim Potentiometer 1 connector for any adjustable voltage signal that can be interfaced to experimental circuit on the 2.2”*6.5” breadboard.

The X30 pins connections are:



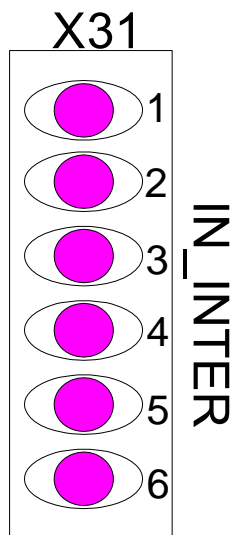
Pin #1 → One end of the 10K Ω Pot

Pin #2 → Center wiper of the Pot 1

Pin #3 → The other end of the 10K Ω Pot

39. **IN Interface Connector (X31)**: These are input signals going to DB25 input pins that can be interfaced to experimental circuit on the 2.2"×6.5" breadboard.

The X31 pins connections are:



Pin #1 → +5V

Pin #2 → IN_3

Pin #3 → IN_5

Pin #4 → IN_6

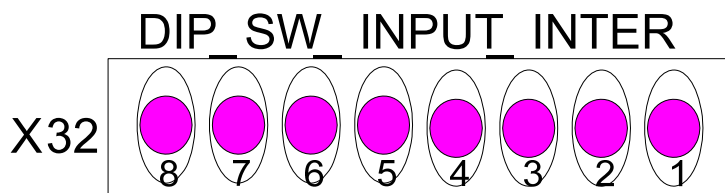
Pin #5 → IN_7

Pin #6 → Gnd

The associate circuits of these input pins are presented in item #48.

40. **8 Positions DIP Digital Input Switch Interface Connector(X32)**: This is an interface for the 8 bit DIP switch to be used as inputs for experimental circuit on the 2.2"×6.5" breadboard.

The X32 pins connections are:



Pin #1 → DIP Switch #1 Down = Gnd/Lo, Up = +5V/Hi

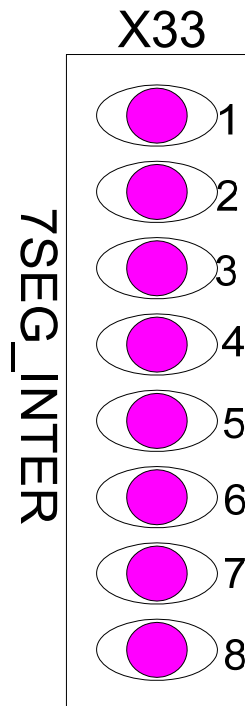
Pin #2 → DIP Switch #2 Down = Gnd/Lo, Up = +5V/Hi

Pin #3 → DIP Switch #3 Down = Gnd/Lo, Up = +5V/Hi

- Pin #4 → DIP Switch #4 Down = Gnd/Lo, Up = +5V/Hi
- Pin #5 → DIP Switch #5 Down = Gnd/Lo, Up = +5V/Hi
- Pin #6 → DIP Switch #6 Down = Gnd/Lo, Up = +5V/Hi
- Pin #7 → DIP Switch #7 Down = Gnd/Lo, Up = +5V/Hi
- Pin #8 → DIP Switch #8 Down = Gnd/Lo, Up = +5V/Hi

41. 7 Segment Interface Connector (X33): This is an interface for data signal to all 4 of the 7 segment display experimental circuit on the 2.2"*6.5" breadboard. To activate one of the four 7 segment, a proper activation signal on the driver connector should be high.

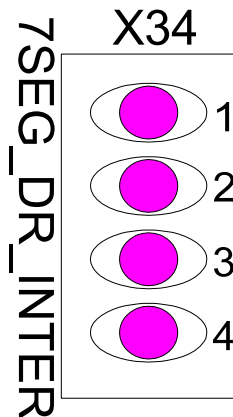
The X33 pins connections are:



- Pin #1 → Segment **a** thru 220Ω Current Limit, Output Lo to Turn on
- Pin #2 → Segment **b** through 220Ω Current Limit, Output Lo to Turn on
- Pin #3 → Segment **c** through 220Ω Current Limit, Output Lo to Turn on
- Pin #4 → Segment **d** through 220Ω Current Limit, Output Lo to Turn on
- Pin #5 → Segment **e** through 220Ω Current Limit, Output Lo to Turn on
- Pin #6 → Segment **f** through 220Ω Current Limit, Output Lo to Turn on
- Pin #7 → Segment **g** through 220Ω Current Limit, Output Lo to Turn on
- Pin #8 → Segment **dp** through 220Ω Current Limit, Output Lo to Turn on

42. 7 Segment Driver Interface Connector (X34): This is a driver signal interface to activate one of the four 7 segment display experimental circuit on the 2.2"*6.5" breadboard.

The X34 pins connections are:

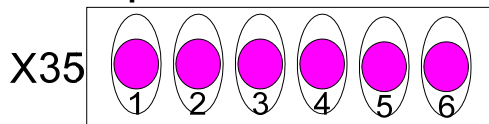


- Pin #1 → Segment #0 On/Off Control, Output Lo to Turn on
- Pin #2 → Segment #1 On/Off Control, Output Lo to Turn on
- Pin #3 → Segment #2 On/Off Control, Output Lo to Turn on
- Pin #4 → Segment #3 On/Off Control, Output Lo to Turn on

43. **IRQ Switch 0 Interface Connector (X35)**: This is an interface for the SPDT switch to be used as inputs for interrupt experimental circuit on the 2.2”*6.5” breadboard. The first 3 connections belong to IRQ Switch 0.

44. **IRQ Switch 1 Interface Connector (X35)**: This is an interface for the SPDT switch to be used as inputs for interrupt experimental circuit on the 2.2”*6.5” breadboard. The second 3 connections belong to IRQ Switch 1.

The X35 pins connections are:



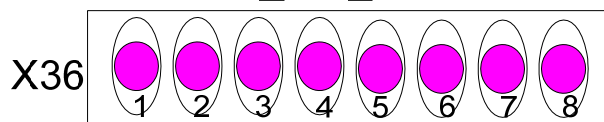
IRQ_SW_INTER

- Pin #1 → IRQ_SW0 C (Common)
- Pin #2 → IRQ_SW0 NO (Normal Open)
- Pin #3 → IRQ_SW0 NC (Normal Close)
- Pin #4 → IRQ_SW1 C (Common)
- Pin #5 → IRQ_SW1 NO (Normal Open)
- Pin #6 → IRQ_SW1 NC (Normal Close)

45. **2.4 GHz Module Interface Connector (X36)**: This is a standard SPI interface for 2.4GHz, MRF24J40MA Module interface for wireless communication on the 2.2”*6.5” breadboard.

The X36 pins connections are:

RF_SPI_INTER



- Pin #1 → RF_RESET
- Pin #2 → RF_WAKE

Pin #3 → RF_INT
 Pin #4 → SDO
 Pin #5 → SCK
 Pin #6 → CLKOUT
 Pin #7 → RF_CS
 Pin #8 → SDI

The associate circuits of these input/SPI interfaces are presented in item #14.

45. **DB BUF IO Interface Connector (X37)**: These are buffered signals from DB25, DB_IO to any 8 bit IO control interface that can be used on experimental circuit on the 2.2"*6.5" breadboard.

The X37 pins connections are:

Pin #2 → BUF_IO_1
 Pin #3 → BUF_IO_2
 Pin #4 → BUF_IO_3
 Pin #5 → BUF_IO_4
 Pin #6 → BUF_IO_5
 Pin #7 → BUF_IO_6
 Pin #8 → BUF_IO_7

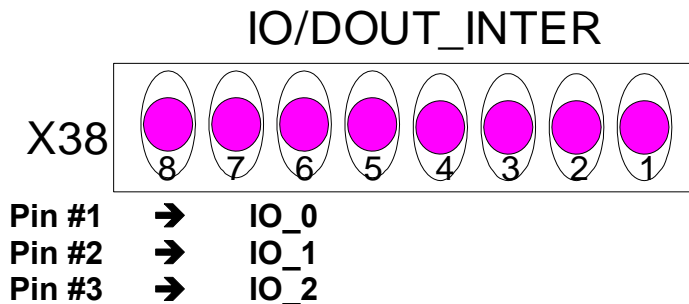
Pin #1 == BUF_IO_0

The associated circuits from DB_IO to BUF_IO signal are:



46. **IO Interface Connector (X38)**: These are signals from DB25, DB_IO to any 8 bit IO control interface that can be used on experimental circuit on the 2.2"*6.5" breadboard. See Item #45 for relation between DB_IO & BUF_IO.

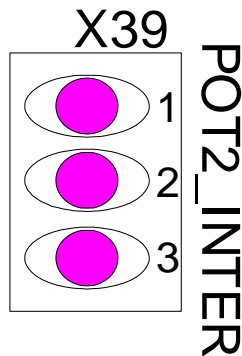
The X38 pins connections are:



Pin #4 → IO_3
 Pin #5 → IO_4
 Pin #6 → IO_5
 Pin #7 → IO_6
 Pin #8 → IO_7

47. **Potentiometer 2 Interface Connector (X39):** These are signals from 10K Ω Trim Potentiometer 2 connector for any adjustable voltage signal that can be interfaced to experimental circuit on the 2.2"×6.5" breadboard.

The X39 pins connections are:



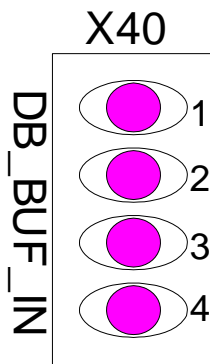
Pin #1 → One end of the 10K Ω Pot

Pin #2 → Center wiper of the Pot 1

Pin #3 → The other end of the 10K Ω Pot

48. **Buffered Input Interface Connector (X40):** These are buffered input signals that are intended for DB25 input purpose that can be interfaced to experimental circuit on the 2.2"×6.5" breadboard.

The X40 pins connections are:



Pin #1 → DB_IN3

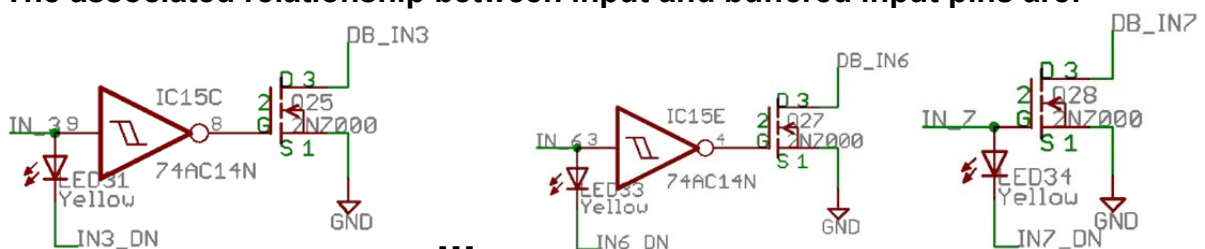
Pin #2 → DB_IN5

Pin #3 → DB_IN6

Pin #4 → DB_IN7

Note: DB_IN7 is inversed

The associated relationship between input and buffered input pins are:



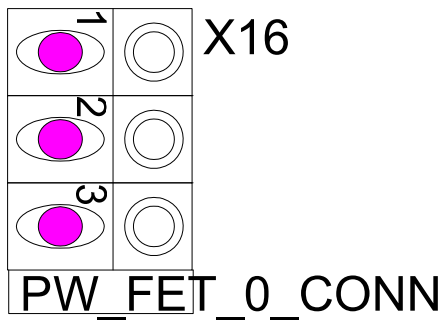
49. Switches 5-12 (S5, S6, S7, S8, S9, S10, S11, S12): These are 8 hardware debounced SPDT switches to be used in experimental circuit on the 2.2"*6.5" breadboard.
50. LED 23-30 (Green LED23, LED24, LED25, LED26, LED27, LED28, LED29, LED3): These are indication LEDs for signal the action on the hardware debounced switches 5-12.
51. LED 3-10 (Red LED3, Green LED4, Yellow LED5, Red LED6, Green LED7, Yellow LED8, Yellow LED9, Yellow LED10): These are indication LEDs for signal output logics on DB_IO_0, DB_IO_1, DB_IO_2, DB_IO_3, DB_IO_4, DB_IO_5, DB_IO_6, DB_IO_7.
52. LED 31-34 (Yellow LED31, Yellow LED32, Yellow LED33, Yellow LED34): These are indication LEDs for input logic signals on IN_3, IN_5, IN_6, & IN_7.

High Power Section

All the high power components are isolated from the low power side (there is no common ground between the low and high power components) and positioned at right side of the PCB and all the interface connectors are terminal blocks for low gauge wire high current connection flow. The graphic symbols representations are the same as they placed on the PCB.

1. **The Power FET 0 Connector (X16)**: The IRF530 power FET 0 is activated by IO_0 logic Hi, if it is activated the OUT_0 pin will be connected to OUT_0_GND pin. This will allow high power on/off control to power ground terminal.

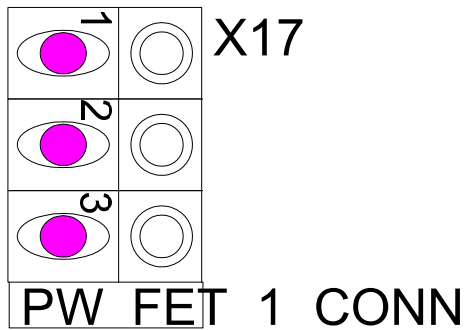
The X16 pins connections are:



Pin #1	→ VCC	==
	Motor Power	
Pin #2	→ OUT_0	==
	Power FET 0 Drain, Connected to OUT_0_GND If Activated	
Pin #3	→ OUT_0_GND	==
	Motor Power GND	

2. **The Power FET 1 Connector (X17)**: The IRF530 power FET 1 is activated by IO_1 logic Hi, if it is activated the OUT_1 pin will be connected to OUT_1_GND pin. This will allow high power on/off control to power ground terminal.

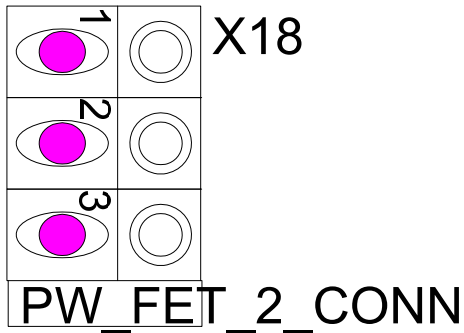
The X17 pins connections are:



Pin #1	→ VCC	==
	Motor Power	
Pin #2	→ OUT_1	==
	Power FET 1 Drain, Connected to OUT_1_GND If Activated	
Pin #3	→ OUT_1_GND	==
	Motor Power GND	

3. **The Power FET 2 Connector (X18)**: The IRF530 power FET 2 is activated by IO_2 logic Hi, if it is activated the OUT_2 pin will be connected to OUT_2_GND pin. This will allow high power on/off control to power ground terminal.

The X18 pins connections are:



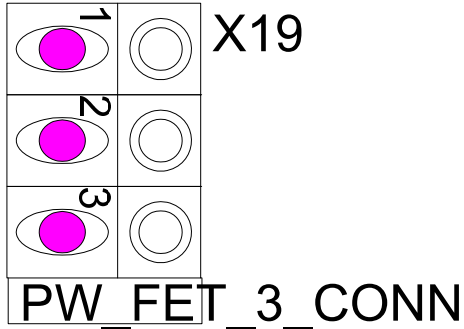
Pin #1 → VCC ==
Motor Power

Pin #2 → OUT_2 ==
Power FET 2 Drain,
Connected to OUT_2_GND If
Activated

Pin #3 → OUT_2_GND ==
Motor Power GND

4. **The Power FET 3 Connector (X19):** The IRF530 power FET 3 is activated by IO_3 logic Hi, if it is activated the OUT_3 pin will be connected to OUT_3_GND pin. This will allow high power on/off control to power ground terminal.

The X19 pins connections are:



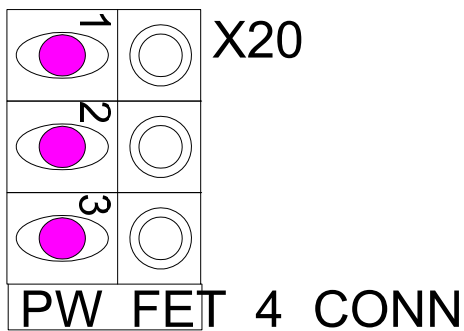
Pin #1 → VCC ==
Motor Power

Pin #2 → OUT_3 ==
Power FET 3 Drain,
Connected to OUT_3_GND If
Activated

Pin #3 → OUT_3_GND ==
Motor Power GND

5. **The Power FET 4 Connector (X20):** The IRF530 power FET 4 is activated by IO_4 logic Hi, if it is activated the OUT_4 pin will be connected to OUT_4_GND pin. This will allow high power on/off control to power ground terminal.

The X20 pins connections are:



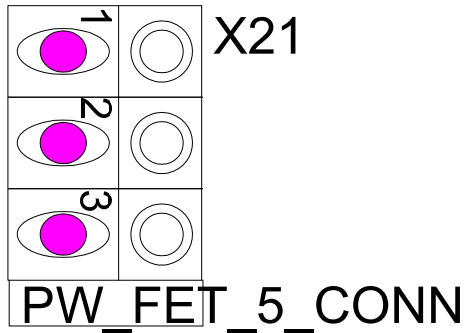
Pin #1 → VCC ==
Motor Power

Pin #2 → OUT_4 ==
Power FET 4 Drain,
Connected to OUT_4_GND If
Activated

Pin #3 → OUT_4_GND ==
Motor Power GND

6. **The Power FET 5 Connector (X21):** The IRF530 power FET 5 is activated by IO_5 logic Hi, if it is activated the OUT_5 pin will be connected to OUT_5_GND pin. This will allow high power on/off control to power ground terminal.

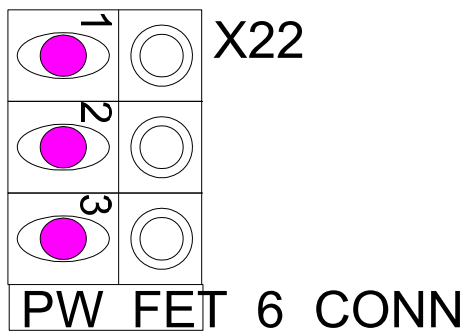
The X21 pins connections are:



Pin #1 → VCC ==
Motor Power
Pin #2 → OUT_5 ==
Power FET 5 Drain,
Connected to OUT_5_GND If
Activated
Pin #3 → OUT_5_GND ==
Motor Power GND

7. **The Power FET 6 Connector (X22):** The IRF530 power FET 6 is activated by IO_6 logic Hi, if it is activated the OUT_6 pin will be connected to OUT_6_GND pin. This will allow high power on/off control to power ground terminal.

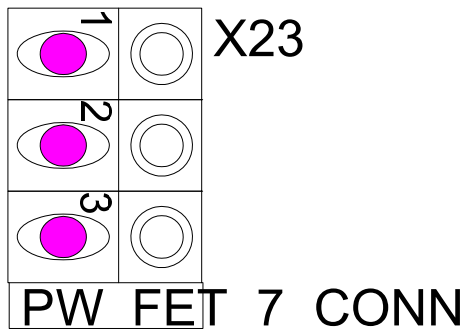
The X22 pins connections are:



Pin #1 → VCC ==
Motor Power
Pin #2 → OUT_6 ==
Power FET 6 Drain,
Connected to OUT_6_GND If
Activated
Pin #3 → OUT_6_GND ==
Motor Power GND

8. **The Power FET 7 Connector (X23):** The IRF530 power FET 7 is activated by IO_7 logic Hi, if it is activated the OUT_7 pin will be connected to OUT_7_GND pin. This will allow high power on/off control to power ground terminal.

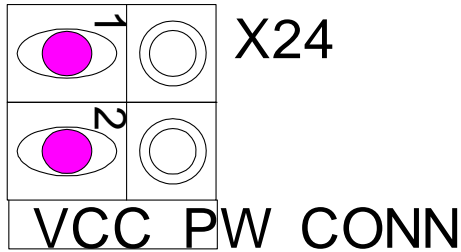
The X23 pins connections are:



Pin #1 → VCC ==
Motor Power
Pin #2 → OUT_7 ==
Power FET 7 Drain,
Connected to OUT_7_GND If
Activated
Pin #3 → OUT_7_GND ==
Motor Power GND

9. **The Motor Power/High Power Connector (X24):** This is the terminals for high power inputs to be use for motor controls. This ground is the same as system +5V ground. To isolate the power ground, wires should be connected directly to power FET ground.

The X24 pins connections are:

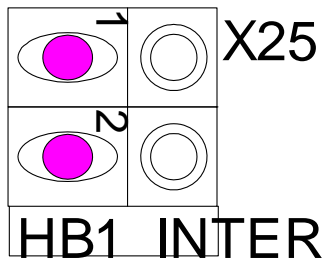


Pin #1 → VCC

Pin #2 → GND

10. **H-Bridge 1 Connector (X25):** This is H-Bridge #1 connector for applications with IRF530 controls on high power Unipolar stepper motor or DC motor directions.

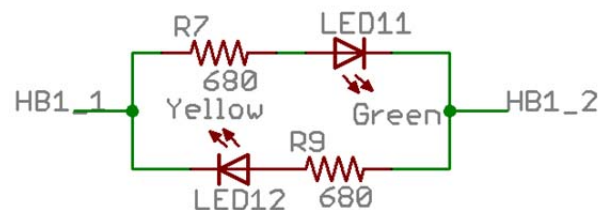
The X25 pins connections are:



Pin #1 → HB1_1

Pin #2 → HB1_2

The associate circuit of this X25 connector is:



Note: IRF530/Q3 is activated via IO_0 logic pin 1 in X38 interface connector.
 IRF530/Q4 is activated via IO_1 logic pin 2 in X38 interface connector.
 IRF530/Q5 is activated via IO_2 logic pin 3 in X38 interface connector.
 IRF530/Q6 is activated via IO_3 logic pin 4 in X38 interface connector.
All the logic signals are isolated through optical isolator between MCU and motor power signals.

Users need to connect proper wires on terminal blocks (X16, X17, X18, & X19) to make the H-Bridge #1, the followings are the suggested connections and their associated circuits stated in item #11.

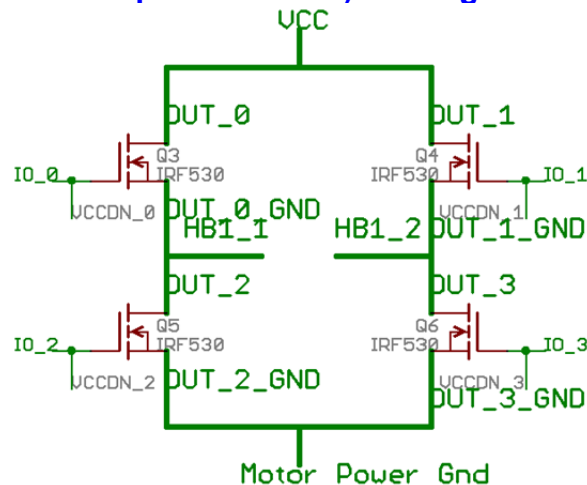
- (1) VCC (motor power, any Pin #1 on X16, X17, X18 or X19) to OUT_0 (Pin #2 on X16) & OUT_1 (Pin #2 on X17)
- (2) OUT_0_GND (Pin #3 on X16) & OUT_2 (Pin #2 on X18) & HB1_1 (Pin #1 on X25)
- (3) OUT_1_GND (Pin #3 on X17) & OUT_3 (Pin #2 on X19) & HB1_2 (Pin #2 on X25)
- (4) OUT_2_GND (Pin #3 on X18) & OUT_3_GND (Pin #3 on X19) to Motor Power GND (Pin #2 on X24)
- (5) HB1_1 (Pin #1 on X25) & HB1_2 (Pin #2 on X25) to Motor Terminals.

Activate IO_0 and IO_3 to and disable IO_1 and IO_2 to drive DC motor in one direction.

Activate IO_1 and IO_2 to and disable IO_0 and IO_3 to drive DC motor in the other direction.

Note: In this configuration, never active both IRF530/Q3 (IO_0) & IRF530/Q5 (IO_2) and/or both IRF530/Q4 (IO_1) & IRF530/Q6 (IO_3) at the same time. This will cause a direct short of VCC to GND.

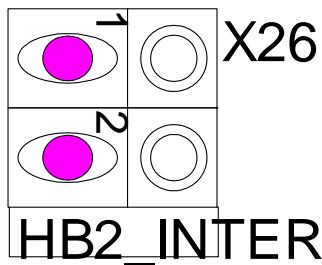
11. The Equivalent H-Bridge (HB1) Circuit with IO and IRF530: The equivalent H-Bridge 1 circuit connections that described in item #10 are presented as:
(Note: the IO_0, IO_1, IO_2, IO_3 are not directly connected (they go through the optical isolator) to the gates of the associate IRFs)



12. LED11/Green & LED12/Yellow: These are current direction flow indicators for H-Bridge #1 control applications.

13. H-Bridge 2 Connector (X26): This is H-Bridge #2 connector for applications with IRF530 controls on high power Unipolar stepper motor or DC motor directions.

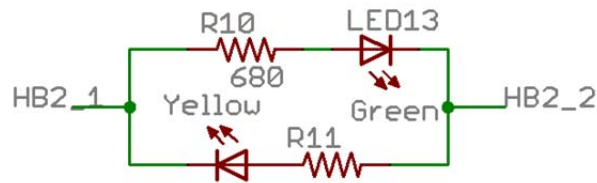
The X26 pins connections are:



Pin #1 → HB2_1

Pin #2 → HB2_2

The associate circuit of this X26 connector is:



Note: IRF530/Q7 is activated via IO_4 logic pin 5 in X38 interface connector.
 IRF530/Q8 is activated via IO_5 logic pin 6 in X38 interface connector.
 IRF530/Q9 is activated via IO_6 logic pin 7 in X38 interface connector.
 IRF530/Q10 is activated via IO_7 logic pin 8 in X38 interface connector.
All the logic signals are isolated through optical isolator between MCU and motor power signals.

Users need to connect proper wires on terminal blocks (X20, X21, X22, X23) to make the H-Bridge #2, the followings are the suggested connections and their associated circuits stated in item #14.

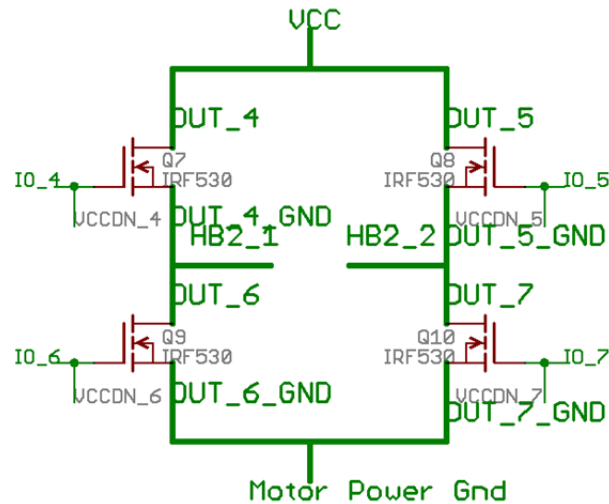
- (1) VCC (motor power, any Pin #1 on X20, X21, X22 or X23) to OUT_4 & (Pin #2 on X20) OUT_5 (Pin #2 on X21)
- (2) OUT_4_GND (Pin #3 on X20) & OUT_6 (Pin #2 on X22) & HB2_1 (Pin #1 on X26)
- (3) OUT_5_GND (Pin #3 on X21) & OUT_7 (Pin #2 on X23) & HB2_2 (Pin #2 on X26)
- (4) OUT_6_GND (Pin #3 on X22) & OUT_7_GND (Pin #3 on X23) to Motor Power GND (Pin #2 on X24)
- (5) HB2_1 (Pin #1 on X26) & HB2_2 (Pin #2 on X26) to Motor Terminals.

Activate IO_4 and IO_7 to and disable IO_5 and IO_6 to drive DC motor in one direction.

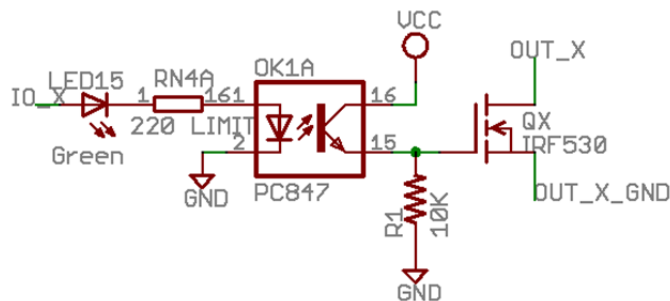
Activate IO_5 and IO_6 to and disable IO_4 and IO_7 to drive DC motor in the other direction.

Note: In this configuration, never active both IRF530/Q7 (IO_4) & IRF530/Q9 (IO_6) and/or both IRF530/Q8 (IO_5) & IRF530/Q10 (IO_7) at the same time. This will cause a direct short of VCC to GND.

14. **The Equivalent H-Bridge (HB2) Circuit with IO and IRF530:** The equivalent H-Bridge 1 circuit connections that described in item #4 are presented as:
 (Note: the IO_4, IO_5, IO_6, IO_7 are not directly connected (they go through the optical isolator) to the gates of the associate IRFs)



15. **LED13/Green & LED14/Yellow:** These are current direction flow indicators for H-Bridge #2 control applications.
16. **Optical Isolator and IRF530 Connection:** The actual circuit that uses optical isolator with IRF530 on/off control is presented as following:



Software Operations:

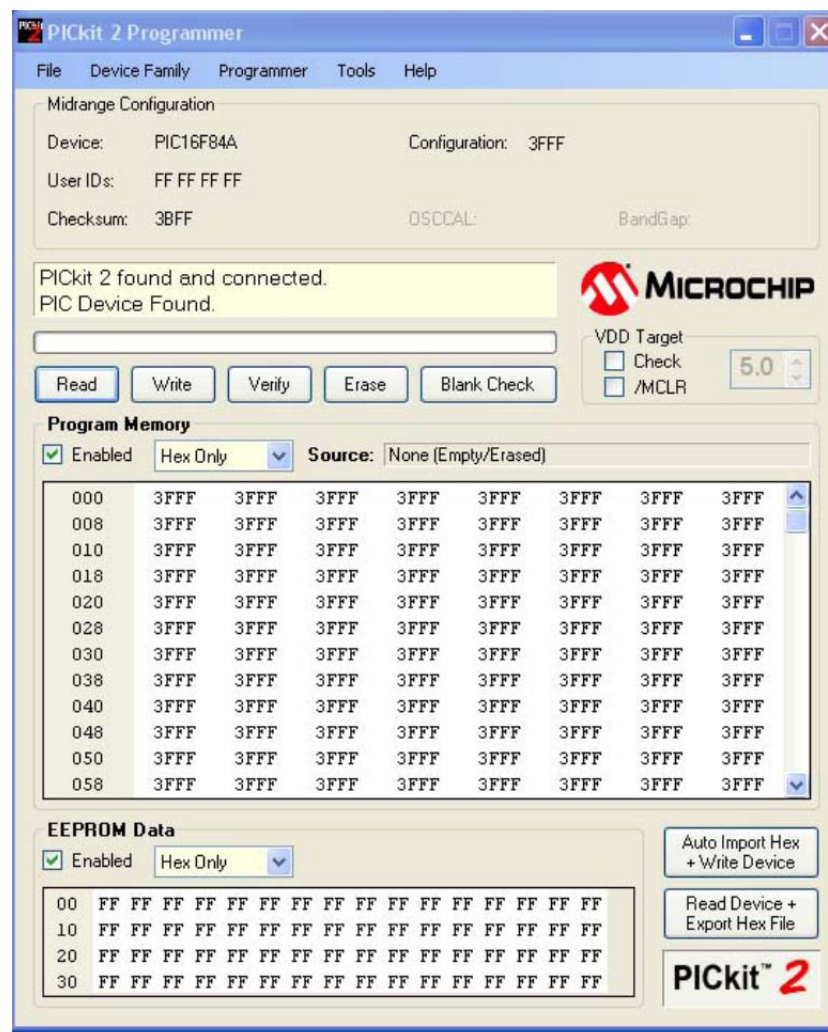
PICKIT2 PIC Programming

Download the PICKIT2 2.61V: This software is available

www.microchip.com/pickit2

After the installation and execute the software, you should be able to see a menu screen like this:

1. **Device**: It is an indication of what type of PIC family member is currently in the ZIF socket.
2. **Configuration**: It indicates what configuration word is in your source code setting.
3. **Status Bar**: It indicates the communication status.
4. **Read**: It reads the content of the PIC flash and EEPROM.



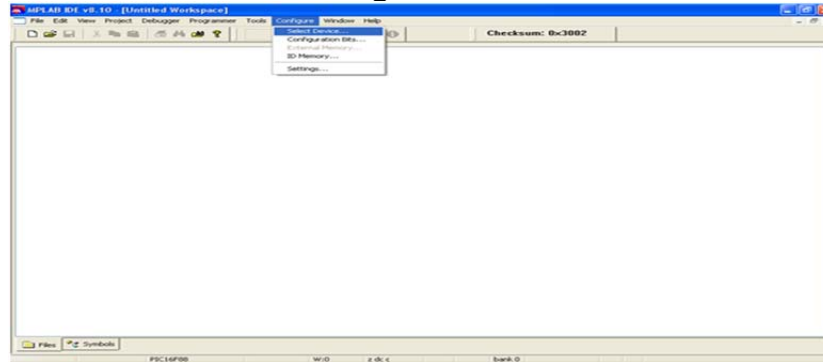
5. **Write**: It writes the source code (.HEX file) to the PIC flash memory.
6. **Verify**: It verifies the content of the PIC with the buffer memory in a PC.
7. **Erase**: It erases the content of flash and EEPROM memory from the PIC.
8. **Blank Check**: It checks the content of flash and EEPROM memory for blank.
9. **Program Memory**: It indicates the flash memory content of the PIC or the PC buffer memory.
10. **EEPROM Memory**: It indicates the EEPROM memory content of the PIC or the PC buffer memory.
11. **File Menu - Import Hex**: Load the .HEX into the PC buffer memory. This has to be done before any programming of a PIC can proceed.
12. **File Menu - Export Hex**: Write the PC buffer memory to a file on the PC. This enables you to upload the flash memory content of the PIC to a PC and make it a .HEX file.
13. **Device Family Menu**: This allows you to choose different PIC family member for programming purpose.
14. **Programmer Menu**: This is the same as Read, Write, Verify, Erase, Blank Check as describe before.
15. **Tools Menu– Check Communication**: This allows you to check the USB communication between the programmer board and a PC connection.

Note: There are features in the PICKIT2 software that is related to Microchip hardware but not usable in this ODU programmer. NOT every function in the PICKIT2 software is implemented in this programmer hardware design.

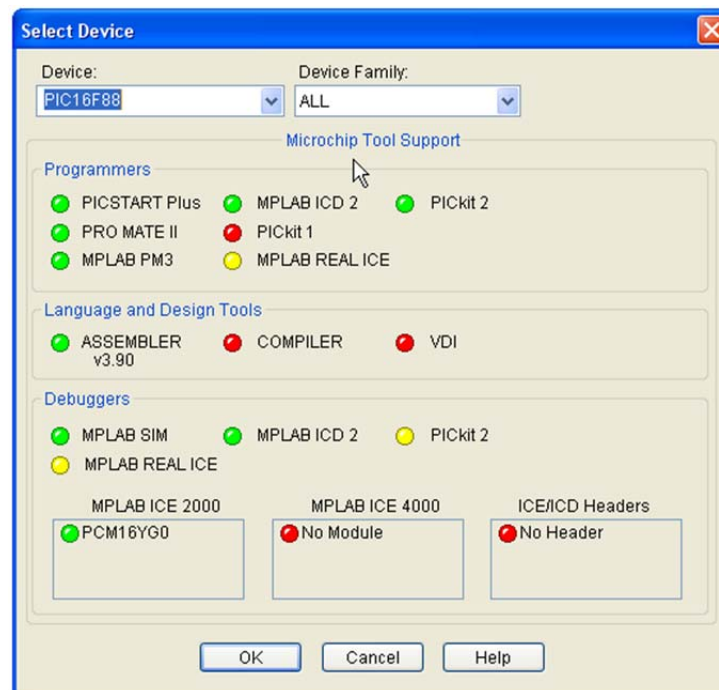
MPLAB IDE PIC Programming

Note: MPLAB does not support PIC16F84A programming.

1. Under the main manual, select **Configure**, choose **Select Device ...**

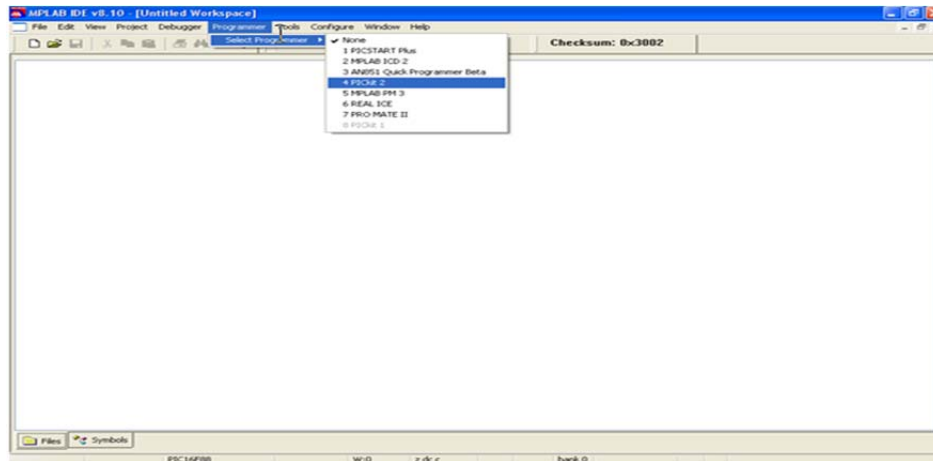


2. From the Select Device manual, choose proper target MCU that you are using for program:

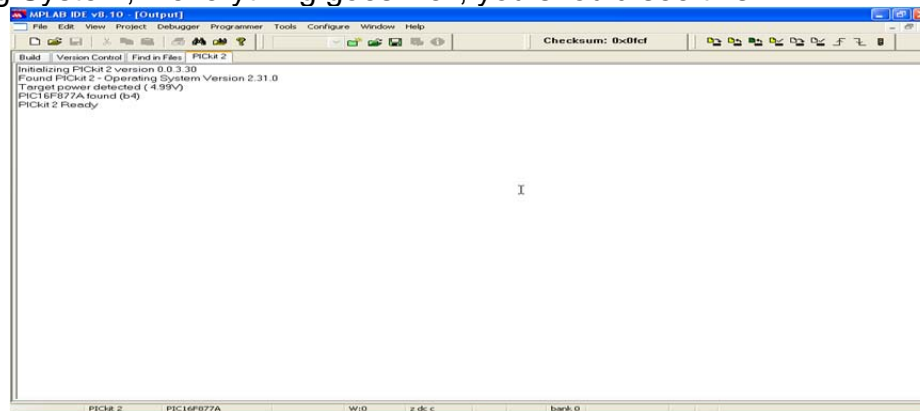


Note: There are limited numbers of MCU that MPLAB IDE support PICKIT2 programming. PIC16F84A is not supported, but PIC16F88 and PIC16F877A are supported by MPLAB IDE/PICKIT2 programming.

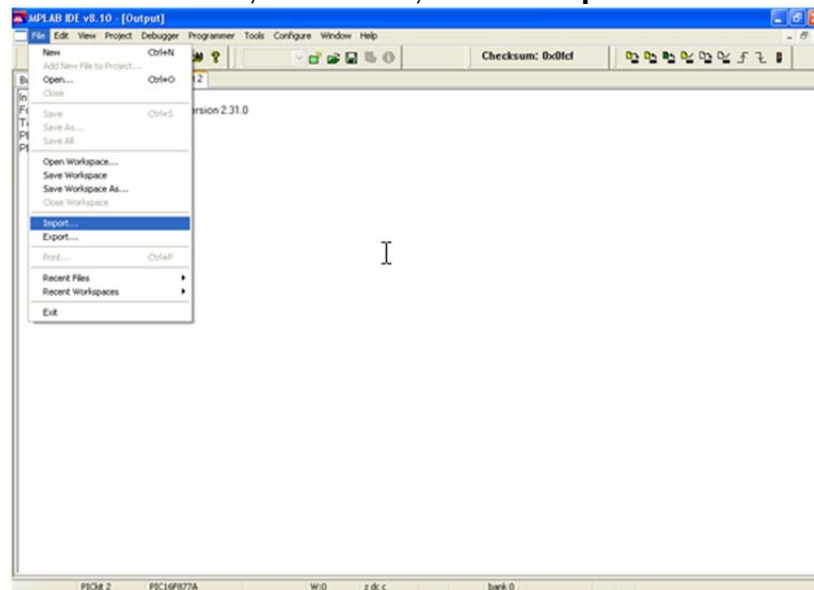
3. After you done with the select device choice, under the MPLAB main manual, select **Programmer**, choose **Select Programmer**, choose **4 PICKIT2**



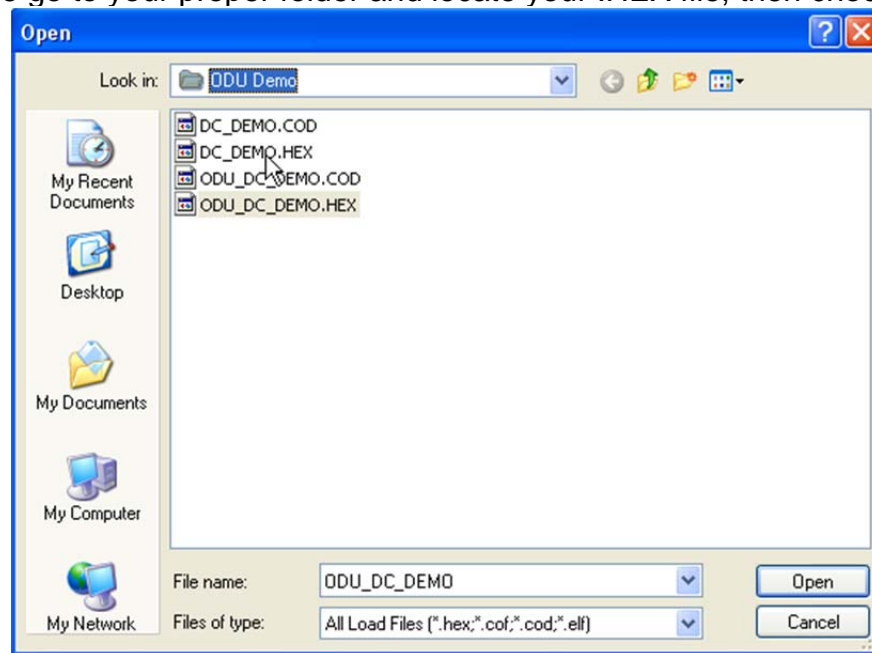
4. After you choose the PICKIT2, the software will start the communication with the PIC Training System, if everything goes well, you should see this:



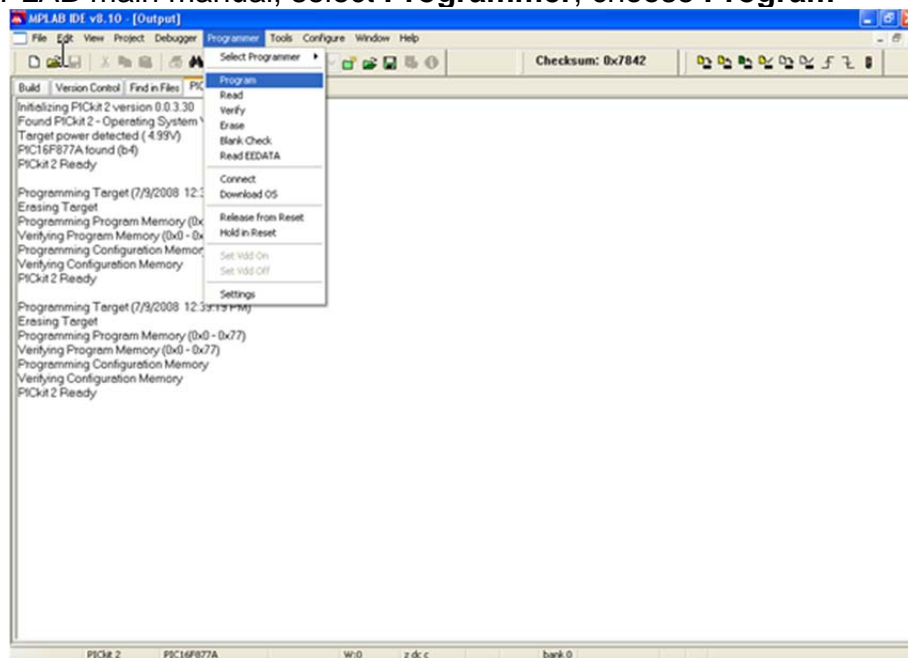
5. If you have the .HEX file ready, you can start programming the target MCU with MPLAB, under the main manual, select **File**, choose **Import...**



6. From here go to your proper folder and locate your .HEX file, then choose **Open**



7. Under MPLAB main manual, select **Programmer**, choose **Program**



8. The software will automatically program the target MCU and report its success on the screen as present above.